



SBR130SV

1.0A SBR[®] SUPER BARRIER RECTIFIER

Features

- Low Leakage Current
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- +150 ℃ Operating Junction Temperature
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

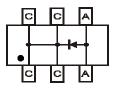
Mechanical Data

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (23)
- Terminal Connections: See Diagram
- Weight: 0.003 grams (Approximate)

SOT563







Top View

Bottom View

Top View Internal Schematic Dot denotes cathode pin 1

Ordering Information (Note 4)

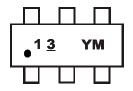
Part Number	Case	Packaging
SBR130SV-7	SOT563	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information

SOT563



1 <u>3</u> = Product Type Marking Code YM = Date Code Marking Y = Year (ex: C = 2015) M = Month ex: 9 = September Dot denotes cathode pin 1

Date Code Key

Year	201	3	2014		2015	20	16	2017		2018	2	2019
Code	Α		В		С)	Е		F		G
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	30	٧
Average Rectified Output Current	Io	1.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	2.5	Α

Thermal Characteristics

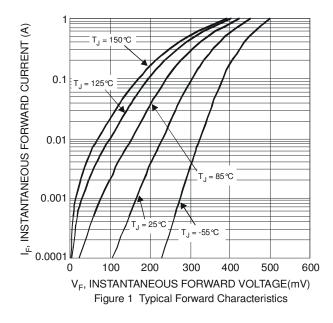
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	150	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	℃

Electrical Characteristics (@TA = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
	VF	_	0.31	0.38	V	I _F = 0.1A, T _J = +25 ℃
Famusand Valtages Disas		_	0.39	0.46		I _F = 0.5A, T _J = +25 ℃
Forward Voltage Drop		_	_	0.56		I _F = 1.0A, T _J = +25 ℃
		_	0.40	0.45		I _F = 1.0A, T _J = +125℃
	I _R	_	4	25	μΑ	V _R = 5V, T _J = +25 ℃
			5	30		V _R = 12V, T _J = +25°C
Lookaga Current (Note 6)		1	13	80		$V_R = 30V, T_J = +25$ °C
Leakage Current (Note 6)		1	140	1,400		$V_R = 5V$, $T_J = +85$ °C
			175	1,800		V _R = 12V, T _J = +85 °C
			2,300			$V_R = 30V, T_J = +125$ °C

Notes:

- 5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.



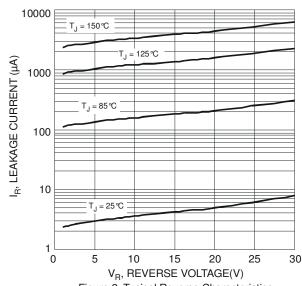
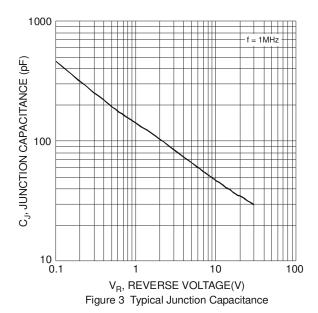
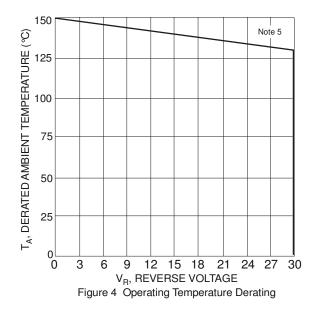


Figure 2 Typical Reverse Characteristics

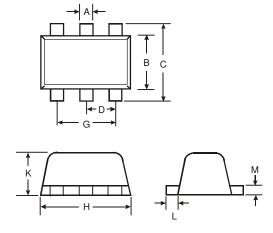






Package Outline Dimensions

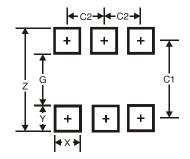
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT563						
Dim	Min	Max	Тур			
Α	0.15	0.30	0.20			
В	1.10	1.25	1.20			
С	1.55	1.70	1.60			
D	-	-	0.50			
G	0.90	1.10	1.00			
Н	1.50	1.70	1.60			
K	0.55	0.60	0.60			
L	0.10	0.30	0.20			
М	0.10	0.18	0.11			
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Υ	0.5
C1	1.7
C2	0.5



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